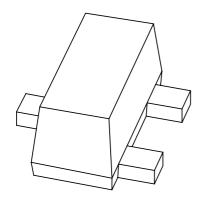
#### **DISCRETE SEMICONDUCTORS**

## DATA SHEET



# PBSS2515F15 V low V<sub>CEsat</sub> NPN transistor

Product specification Supersedes data of 2001 Jan 26 2001 Sep 21





## 15 V low V<sub>CEsat</sub> NPN transistor

#### **PBSS2515F**

#### **FEATURES**

- · Low collector-emitter saturation voltage
- · High current capabilities
- Improved thermal behaviour due to flat leads.

#### **APPLICATIONS**

- · General purpose switching and muting
- · Low frequency driver circuits
- LCD backlighting
- · Audio frequency general purpose amplifier applications
- Battery driven equipment (mobile phones, video cameras and hand-held devices).

#### **DESCRIPTION**

NPN low V<sub>CEsat</sub> transistor in a SC-89 (SOT490) plastic package.

PNP complement: PBSS3515F.

#### **MARKING**

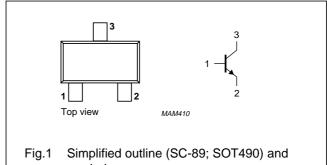
TYPE NUMBER	MARKING CODE		
PBSS2515F	2A		

#### **QUICK REFERENCE DATA**

SYMBOL	PARAMETER	MAX.	UNIT
V <sub>CEO</sub>	collector-emitter voltage	15	V
I <sub>C</sub>	collector current (DC)	500	mA
I <sub>CM</sub>	peak collector current	1	Α
R <sub>CEsat</sub>	equivalent on-resistance	<500	mΩ

#### **PINNING**

PIN	DESCRIPTION	
1	base	
2	emitter	
3	collector	



symbol.

#### **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>CBO</sub>	collector-base voltage	open emitter	_	15	V
V <sub>CEO</sub>	collector-emitter voltage	open base	_	15	V
V <sub>EBO</sub>	emitter-base voltage	open collector	_	6	V
I <sub>C</sub>	collector current (DC)		_	500	mA
I <sub>CM</sub>	peak collector current		_	1	Α
I <sub>BM</sub>	peak base current		_	100	mA
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	_	250	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T <sub>amb</sub>	operating ambient temperature		-65	+150	°C

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#### THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R <sub>th j-a</sub>	thermal resistance from junction to	in free air	500	K/W
	ambient			

#### **CHARACTERISTICS**

 $T_{amb}$  = 25 °C; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I <sub>CBO</sub>	collector-base cut-off current	V <sub>CB</sub> = 15 V; I <sub>E</sub> = 0	_	_	100	nA
		V <sub>CB</sub> = 15 V; I <sub>E</sub> = 0; T <sub>j</sub> = 150 °C	_	_	50	μΑ
I <sub>EBO</sub>	emitter-base cut-off current	V <sub>EB</sub> = 5 V; I <sub>C</sub> = 0	_	_	100	nA
h <sub>FE</sub>	DC current gain	V <sub>CE</sub> = 2 V; I <sub>C</sub> = 10 mA	200	_	_	
		$V_{CE} = 2 \text{ V}; I_{C} = 100 \text{ mA}; \text{ note } 1$	150	_	_	
		V <sub>CE</sub> = 2 V; I <sub>C</sub> = 500 mA; note 1	90	_	_	
V <sub>CEsat</sub>	collector-emitter saturation	$I_C = 10 \text{ mA}; I_B = 0.5 \text{ mA}$	_	_	25	mV
	voltage	$I_C = 200 \text{ mA}; I_B = 10 \text{ mA}$	_	_	150	mV
		$I_C = 500 \text{ mA}; I_B = 50 \text{ mA}; \text{ note 1}$	_	_	250	mV
R <sub>CEsat</sub>	equivalent on-resistance	$I_C = 500 \text{ mA}; I_B = 50 \text{ mA}$	_	300	<500	mΩ
V <sub>BEsat</sub>	base-emitter saturation voltage	$I_C = 500 \text{ mA}$ ; $I_B = 50 \text{ mA}$ ; note 1	_	_	1.1	V
V <sub>BE</sub>	base-emitter turn-on voltage	V <sub>CE</sub> = 2 V; I <sub>C</sub> = 100 mA; note 1	_	_	0.9	V
f <sub>T</sub>	transition frequency	I <sub>C</sub> = 100 mA; V <sub>CE</sub> = 5 V; f = 100 MHz	250	420	_	MHz
C <sub>c</sub>	collector capacitance	$V_{CB} = 10 \text{ V}; I_E = I_e = 0; f = 1 \text{ MHz}$	_	4.4	6	pF

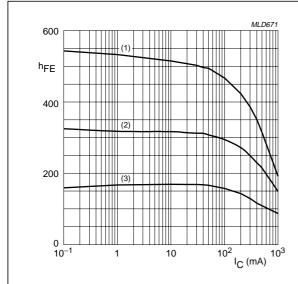
#### Note

1. Pulse test:  $t_p \le 300~\mu s;~\delta \le 0.02.$ 

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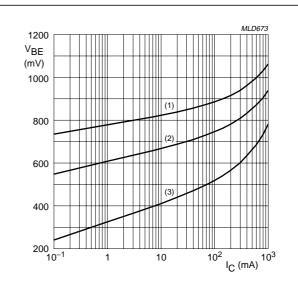
#### PBSS2515F



 $V_{CE} = 2 V.$ 

- (1)  $T_{amb} = 150 \, ^{\circ}C$ .
- (2) T<sub>amb</sub> = 25 °C.
- (3)  $T_{amb} = -55$  °C.

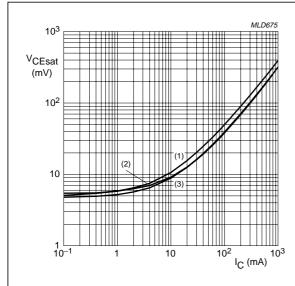
Fig.2 DC current gain as a function of collector current; typical values.



 $V_{CE} = 2 V$ .

- (1)  $T_{amb} = 150 \, ^{\circ}C$ .
- (2) T<sub>amb</sub> = 25 °C.
- (3)  $T_{amb} = -55 \, ^{\circ}C$ .

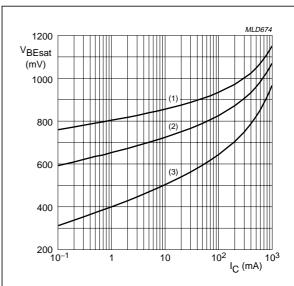
Fig.3 Base-emitter voltage as a function of collector current; typical values.



 $I_{\rm C}/I_{\rm B} = 20.$ 

- (1)  $T_{amb} = 150 \, ^{\circ}C$ .
- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = -55 \, ^{\circ}C$ .

Fig.4 Collector-emitter saturation voltage as a function of collector current; typical values.



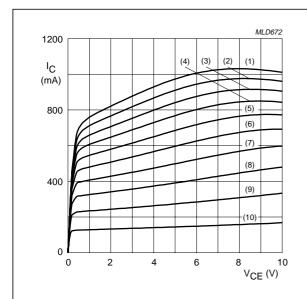
 $I_{\rm C}/I_{\rm B} = 20.$ 

- (1)  $T_{amb} = 150 \,^{\circ}C$ .
- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = -55 \, ^{\circ}C$ .

Fig.5 Base-emitter saturation voltage as a function of collector current; typical values.

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 $T_{amb} = 25 \, ^{\circ}C.$ 

(1)  $I_B = 4.60 \text{ nA}$ .

(5)  $I_B = 2.76 \text{ nA}.$ 

(9)  $I_B = 0.92 \text{ nA}.$ (10)  $I_B = 0.46 \text{ nA}$ .

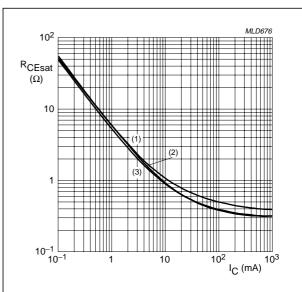
(2)  $I_B = 4.14 \text{ nA}.$ (3)  $I_B = 3.68 \text{ nA}.$  (6)  $I_B = 2.30 \text{ nA}.$ 

(7)  $I_B = 1.84 \text{ nA}.$ 

(4)  $I_B = 3.22 \text{ nA}$ .

(8)  $I_B = 1.38 \text{ nA}.$ 

Fig.6 Collector current as a function of collector-emitter voltage; typical values.



 $I_{\rm C}/I_{\rm B} = 20$ .

(1)  $T_{amb} = 150 \, ^{\circ}C$ .

(2)  $T_{amb} = 25 \, ^{\circ}C$ .

(3)  $T_{amb} = -55 \, ^{\circ}C$ .

Collector-emitter equivalent on-resistance as a function of collector current; typical values.

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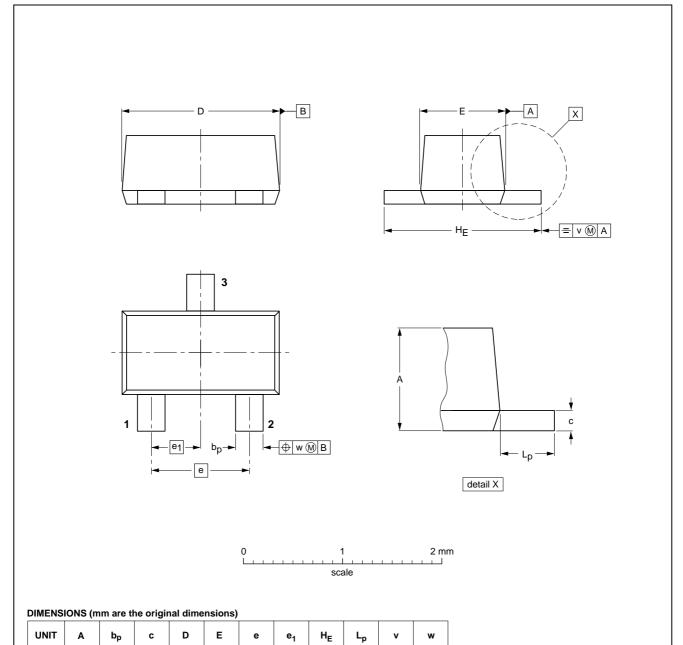
## 15 V low $V_{\text{CEsat}}$ NPN transistor

PBSS2515F

#### **PACKAGE OUTLINE**

Plastic surface mounted package; 3 leads

SOT490



OUTLINE	REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ		PROJECTION ISSUE DA	
SOT490			SC-89			98-10-23

0.5

0.5 0.3

0.1

0.1

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0.8

mm

0.33 0.23 0.2 0.1

1.7 1.5 0.95 0.75

#### 15 V low V<sub>CEsat</sub> NPN transistor

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DATA SHEET STATUS(1)	PRODUCT STATUS <sup>(2)</sup>	DEFINITIONS
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